



SY58608U

3.2Gbps Precision, 1:2 LVDS Fanout Buffer with Internal Termination and Fail Safe Input

General Description

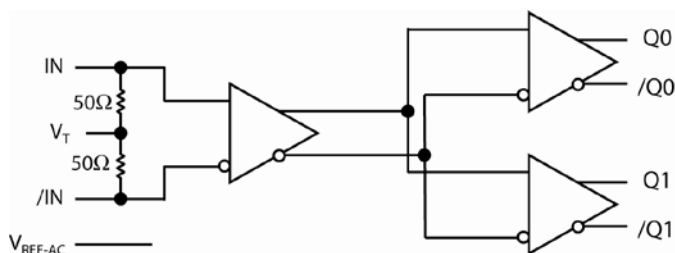
The SY58608U is a 2.5V, high-speed, fully differential 1:2 LVDS fanout buffer optimized to provide two identical output copies with less than 20ps of skew and 130fs_{RMS} typical additive phase jitter. The SY58608U can process clock signals as fast as 2GHz or data patterns up to 3.2Gbps.

The differential input includes Micrel's unique, 3-pin input termination architecture that interfaces to LVPECL, LVDS or CML differential signals, (AC- or DC-coupled) as small as 100mV (200mV_{PP}) without any level-shifting or termination resistor networks in the signal path. For AC-coupled input interface applications, an integrated voltage reference (V_{REF-AC}) is provided to bias the V_T pin. The outputs are 325mV LVDS, with rise/fall times guaranteed to be less than 100ps.

The SY58608U operates from a 2.5V $\pm 5\%$ supply and is guaranteed over the full industrial temperature range (-40°C to $+85^\circ\text{C}$). For applications that require CML or LVPECL outputs, consider Micrel's SY58606U and SY58607U, 1:2 fanout buffers with 400mV and 800mV output swings respectively. The SY58608U is part of Micrel's high-speed, Precision Edge[®] product line.

Data sheets and support documentation can be found on Micrel's web site at: www.micrel.com.

Functional Block Diagram



Features

- Precision 1:2, 325mV LVDS fanout buffer
- Guaranteed AC performance over temperature and voltage:
 - DC-to > 3.2Gbps throughput
 - <300ps propagation delay (IN-to-Q)
 - <20ps within-device skew
 - <100ps rise/fall times
- Fail Safe Input
 - Prevents outputs from oscillating when input is invalid
- Ultra-low jitter design
 - 130fs_{RMS} typical additive phase jitter
 - High-speed LVDS outputs
- 2.5V $\pm 5\%$ power supply operation
- Industrial temperature range: -40°C to $+85^\circ\text{C}$
- Available in 16-pin (3mm x 3mm) QFN package

Applications

- All SONET clock and data distribution
- Fibre Channel clock and data distribution
- Gigabit Ethernet clock and data distribution
- Backplane distribution

Markets

- DataCom
- Telecom
- Storage
- ATE
- Test and Measurement

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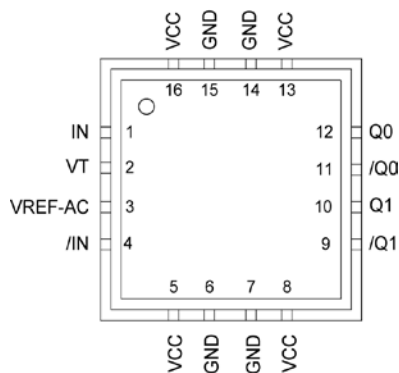
Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY58608UMG	QFN-16	Industrial	608U with Pb-Free bar-line indicator	NiPdAu Pb-Free
SY58608UMGTR ⁽²⁾	QFN-16	Industrial	608U with Pb-Free bar-line indicator	NiPdAu Pb-Free

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC Electricals only.
2. Tape and Reel.

Pin Configuration



16-Pin QFN

Pin Description

Pin Number	Pin Name	Pin Function
1, 4	IN, /IN	Differential Inputs: This input pair is the differential signal input to the device. Input accepts DC-coupled differential signals as small as 100mV (200mV _{PP}). Each pin of this pair internally terminates with 50Ω to the VT pin. If the input swing falls below a certain threshold (typical 30mV), the Fail Safe Input (FSI) feature will guarantee a stable output by latching the outputs to its last valid state. See "Input Interface Applications" section for more details.
2	VT	Input Termination Center-Tap: Each input terminates to this pin. The VT pin provides a center-tap for each input (IN, /IN) to a termination network for maximum interface flexibility. See "Input Interface Applications" section.
3	VREF-AC	Reference Voltage: This output bias to V _{CC} -1.2V. It is used for AC-coupling inputs IN and /IN. Connect VREF-AC directly to the VT pin. Bypass with 0.01μF low ESR capacitor to V _{CC} . Maximum sink/source current is ±1.5mA. See "Input Interface Applications" section for more details.
5, 8, 13, 16	VCC	Positive Power Supply: Bypass with 0.1μF//0.01μF low ESR capacitors as close to the VCC pins as possible.
6, 7, 14, 15	GND, Exposed pad	Ground. Exposed pad must be connected to a ground plane that is the same potential as the ground pin.
9, 10 11, 12	/Q1, Q1 /Q0, Q0	LVDS Differential Output Pairs: Differential buffered output copy of the input signal. The output swing is typically 325mV. Normally terminated 100Ω across the output pairs (Q and /Q). See "LVDS Output Termination" section.

Absolute Maximum Ratings⁽³⁾

Supply Voltage (V_{CC}) -0.5V to +4.0V
 Input Voltage (V_{IN}) -0.5V to $V_{CC} + 0.3V$
 LVDS Output Current (I_{OUT}) $\pm 10mA$
 Input Current
 Source or Sink Current on (IN, /IN) $\pm 50mA$
 Current (V_{REF})
 Source or sink current on V_{REF-AC} ⁽⁶⁾ $\pm 1.5mA$
 Maximum Operating Junction Temperature 125°C
 Lead Temperature (soldering, 20sec.) 260°C
 Storage Temperature (T_s) -65°C to +150°C

Operating Ratings⁽⁴⁾

Supply Voltage (V_{IN}) +2.375V to +2.635V
 Ambient Temperature (T_A) -40°C to +85°C
 Package Thermal Resistance⁽⁵⁾
 QFN
 Still-air (θ_{JA}) 60°C/W
 Junction-to-board (ψ_{JB}) 33°C/W

DC Electrical Characteristics⁽⁷⁾

$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{CC}	Power Supply Voltage Range		2.375	2.5	2.625	V
I_{CC}	Power Supply Current	No load, max. V_{CC}		55	75	mA
R_{DIFF_IN}	Differential Input Resistance (IN-to-/IN)		90	100	110	Ω
V_{IH}	Input HIGH Voltage (IN, /IN)	IN, /IN	1.2		V_{CC}	V
V_{IL}	Input LOW Voltage (IN, /IN)	IN, /IN	0		$V_{IH}-0.1$	V
V_{IN}	Input Voltage Swing (IN, /IN)	see Figure 4, Note 8	0.1		1.7	V
V_{DIFF_IN}	Differential Input Voltage Swing (IN - /IN)	see Figure 6	0.2			V
V_{IN_FSI}	Input Voltage Threshold that Triggers FSI			30	100	mV
V_{REF-AC}	Output Reference Voltage		$V_{CC}-1.3$	$V_{CC}-1.2$	$V_{CC}-1.1$	V
IN to V_T	Voltage from Input to V_T				1.28	V

Notes:

- Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
- The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- Package thermal resistance assumes exposed pad is soldered (or equivalent) to the device's most negative potential on the PCB. ψ_{JB} and θ_{JA} values are determined for a 4-layer board in still-air number, unless otherwise stated.
- Due to the limited drive capability, use for input of the same package only.
- The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
- V_{IN} (max) is specified when V_T is floating.

LVDS Outputs DC Electrical Characteristics⁽⁹⁾

$V_{CC} = +2.5V \pm 5\%$, $R_L = 100\Omega$ across the output pairs; $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OUT}	Output Voltage Swing	See Figure 4, 5	250	325		mV
V_{DIFF_OUT}	Differential Output Voltage Swing	See Figure 6	500	650		mV
V_{OCM}	Output Common Mode Voltage	See Figure 7	1.125	1.20	1.275	V
ΔV_{OCM}	Change in Common Mode Voltage	See Figure 7	-50		50	mV

Notes:

9. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

AC Electrical Characteristics⁽¹⁰⁾

$V_{CC} = +2.5V \pm 5\%$, $R_L = 100\Omega$ across the output pairs, Input $t_r/t_f \leq 300ps$; $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
f_{MAX}	Maximum Frequency	NRZ Data	3.2	4.25		Gbps
		$V_{OUT} > 200mV$ Clock	2	3		GHz
t_{PD}	Propagation Delay IN-to-Q	$V_{IN}: 100mV-200mV$	170	280	420	ps
		$V_{IN}: 200mV-800mV$	130	200	300	ps
t_{Skew}	Within Device Skew	Note 11		5	20	ps
	Part-to-Part Skew	Note 12			135	ps
t_{Jitter}	Additive Phase Jitter	Carrier = 622MHz Integration Range: 12kHz – 20MHz		130		f_{SRMS}
t_r, t_f	Output Rise/Fall Time (20% to 80%)	At full output swing.	35	60	100	ps
	Duty Cycle	Differential I/O	47		53	%

Notes:

10. These high-speed parameters are guaranteed by design and characterization.
11. Within-device skew is measured between two different outputs under identical input transitions.
12. Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and no skew at the edges at the respective inputs.

Functional Description

Fail-Safe Input (FSI)

The input includes a special fail-safe circuit to sense the amplitude of the input signal and to latch the outputs when there is no input signal present, or when the amplitude of the input signal drops sufficiently below 100mV_{PK} (200mV_{PP}), typically 30mV_{PK} . Maximum frequency of SY58608U is limited by the FSI function.

Input Clock Failure Case

If the input clock fails to a floating, static, or extremely low signal swing such that the differential voltage across the input pair is less than 100mV , the FSI function will eliminate a metastable condition and latch the outputs to the last valid state. No ringing and no indeterminate state will occur at the output under these conditions. The output recovers to normal operation once the input signal returns to a valid state with a differential voltage $\geq 100\text{mV}$.

Note that the FSI function will not prevent duty cycle distortion in case of a slowly deteriorating (but still toggling) input signal. Due to the FSI function, the propagation delay will depend on rise and fall time of the input signal and on its amplitude. Refer to "Typical Characteristics" for detailed information.

Timing Diagrams

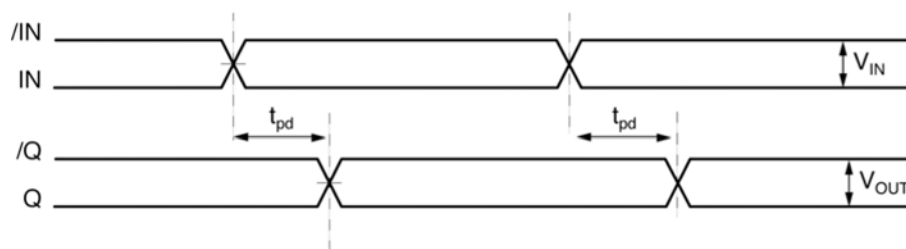


Figure 1. Propagation Delay

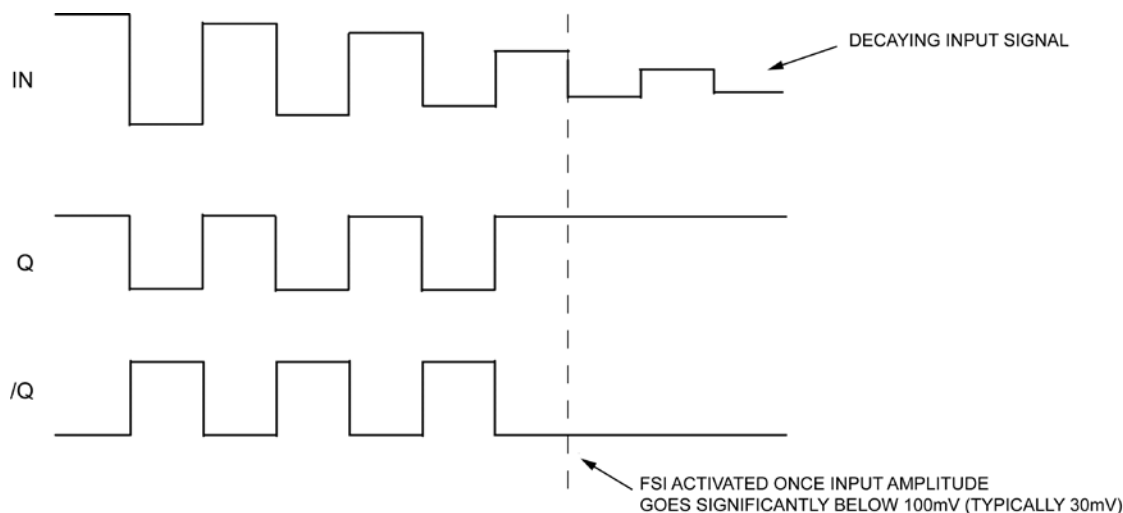
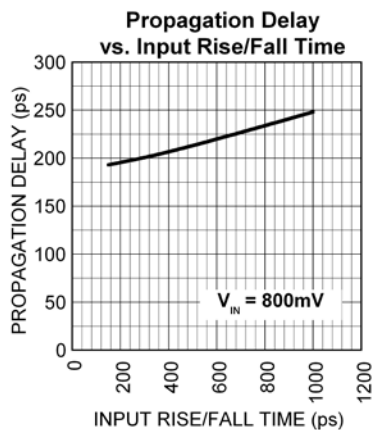
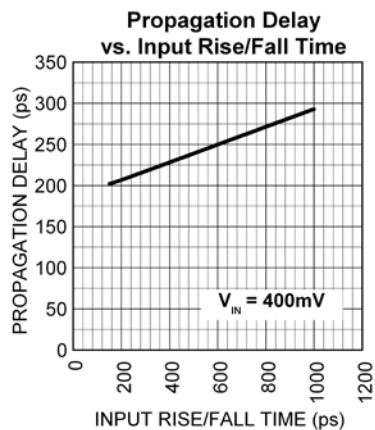
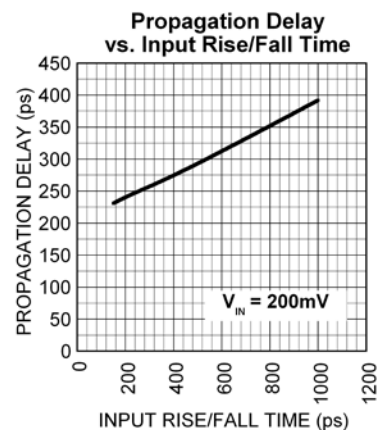
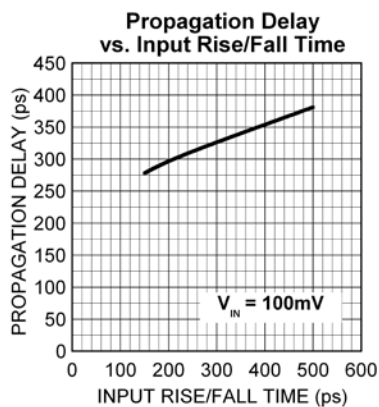
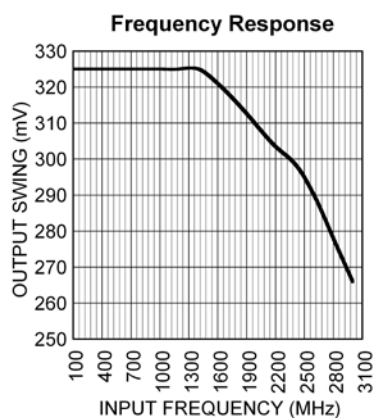


Figure 2. Fail Safe Feature

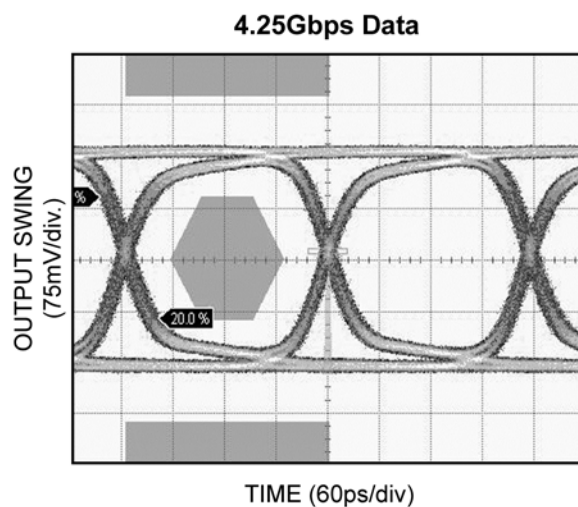
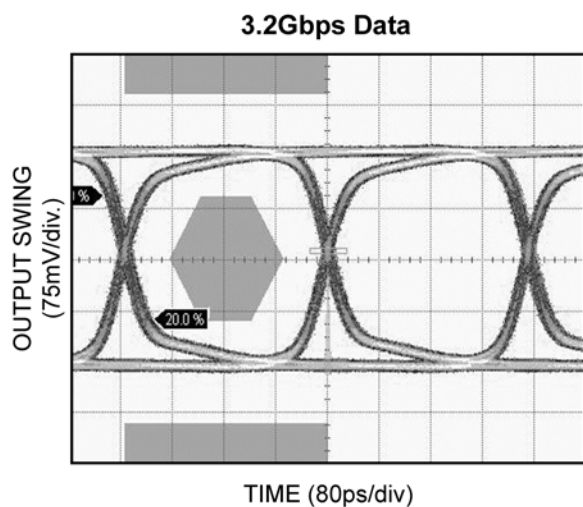
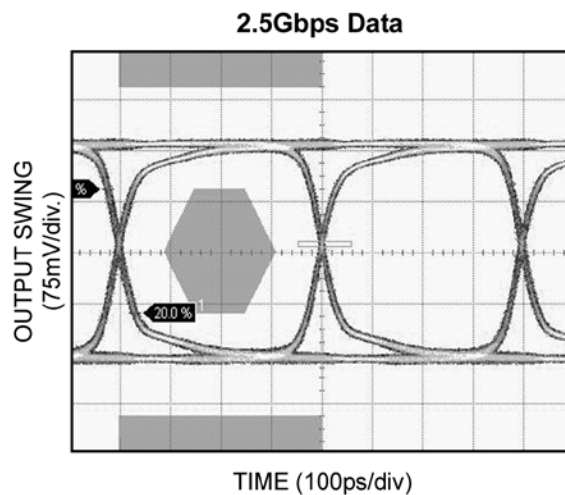
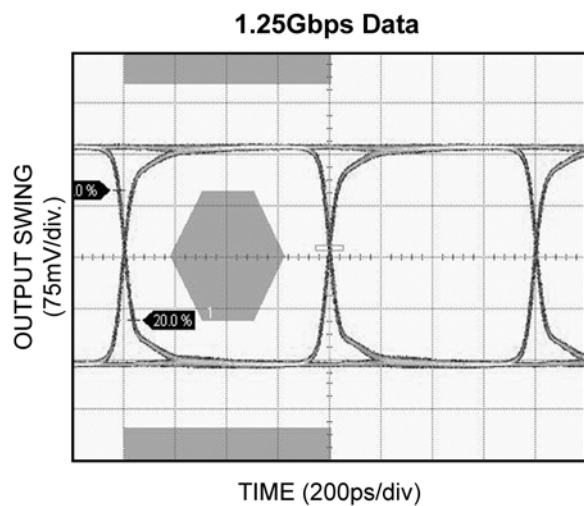
Typical Characteristics

$V_{CC} = 2.5V$, $GND = 0V$, $V_{IN} = 100mV$, $R_L = 100\Omega$ across the output pairs, $T_A = 25^\circ C$, unless otherwise stated.



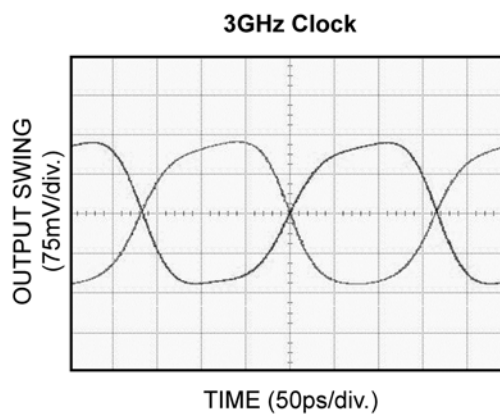
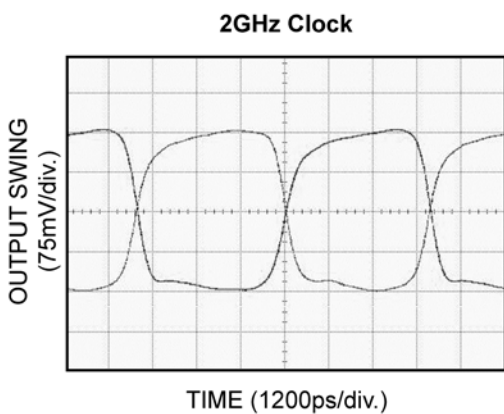
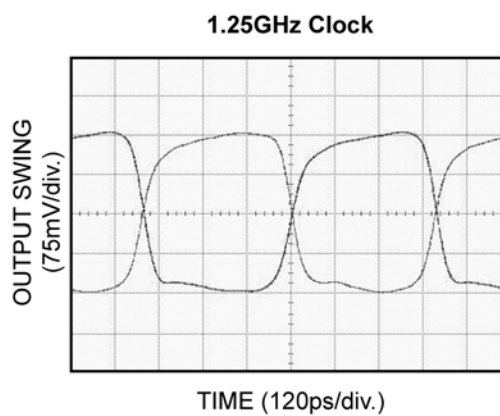
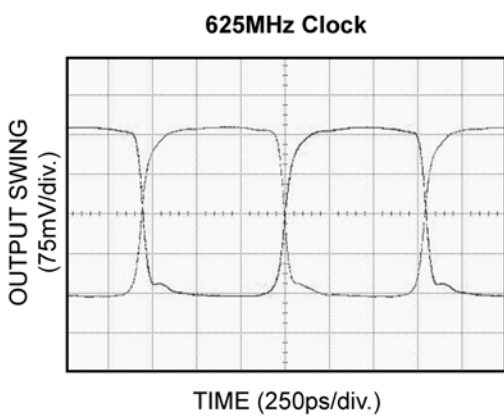
Functional Characteristics

$V_{CC} = 2.5V$, $GND = 0V$, $V_{IN} = 250mV$, Data Pattern: $2^{23}-1$, $R_L = 100\Omega$ across the outputs, $T_A = 25^\circ C$, unless otherwise stated.



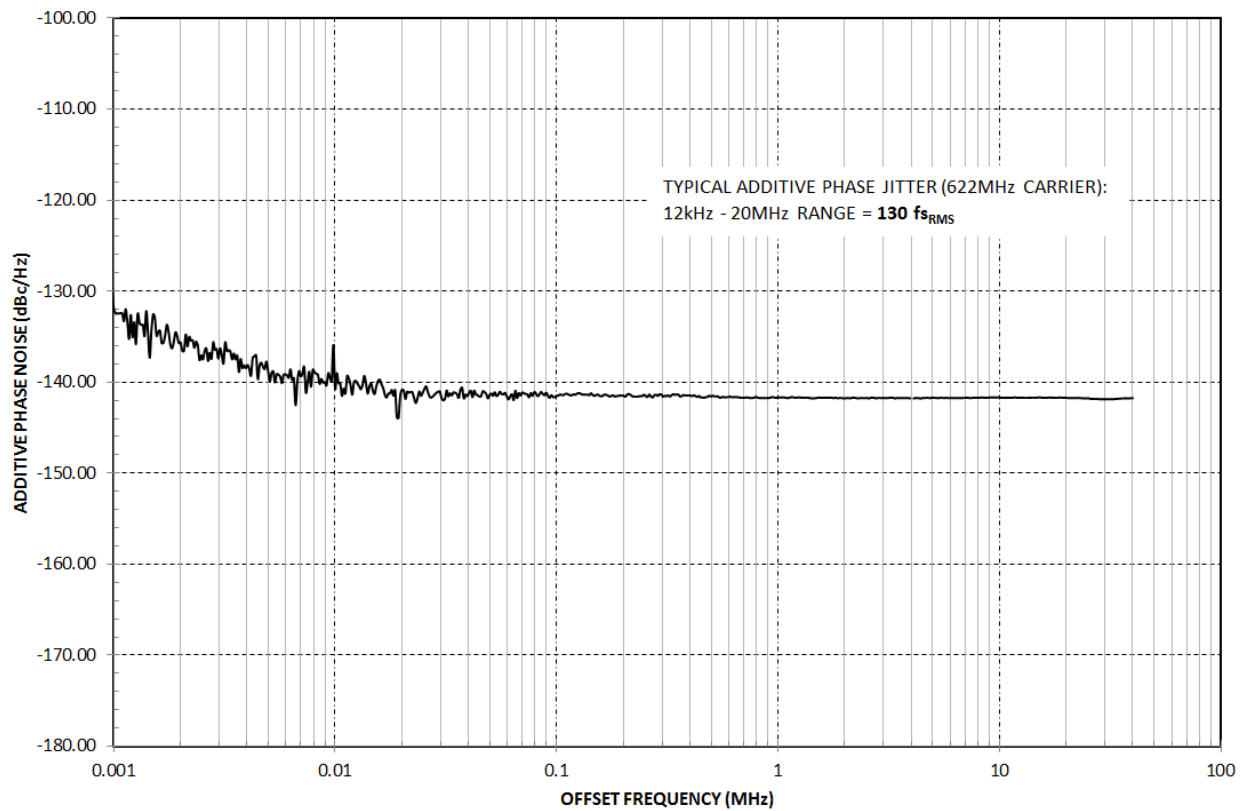
Functional Characteristics (continued)

$V_{CC} = 2.5V$, $GND = 0V$, $V_{IN} = 250mV$, $R_L = 100\Omega$ across the outputs, $T_A = 25^\circ C$, unless otherwise stated.



Additive Phase Noise Plot

$V_{CC} = +3.3V$, $T_A = 25^\circ C$



Input Stage

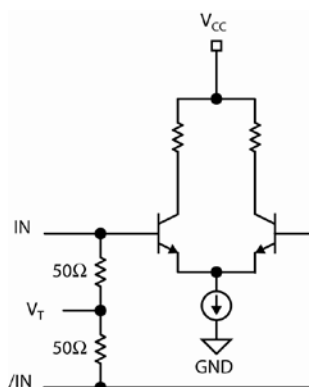


Figure 3. Simplified Differential Input Buffer

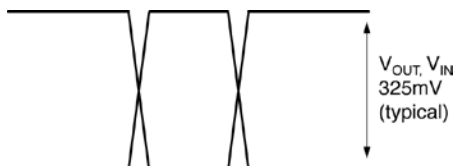


Figure 4. Single-Ended Swing

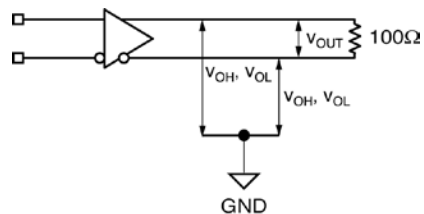


Figure 5. LVDS Differential Measurement

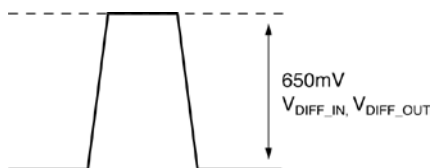


Figure 6. Differential Swing

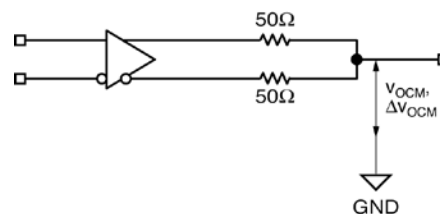
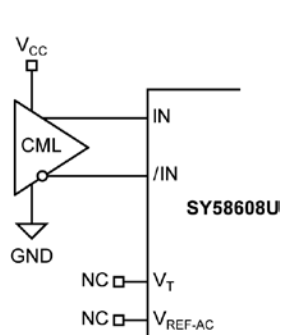


Figure 7. LVDS Common Mode Measurement

Input Interface Applications



**Figure 8. CML Interface
(DC-Coupled)**

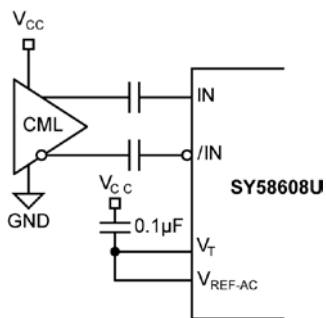


Figure 9. CML Interface (AC-Coupled)

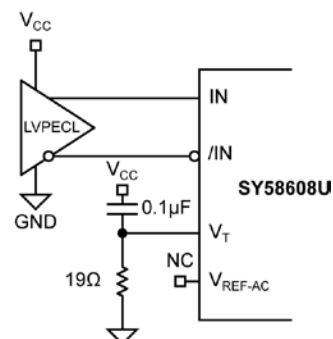


Figure 10. LVPECL Interface (DC-Coupled)

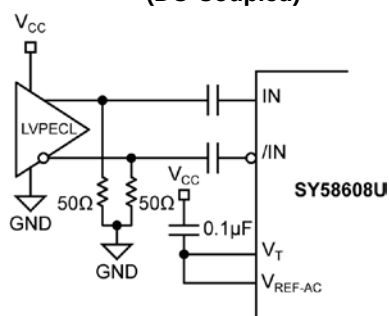


Figure 11. LVPECL Interface (AC-Coupled)

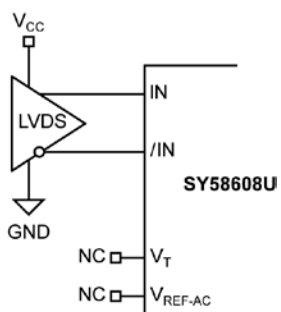
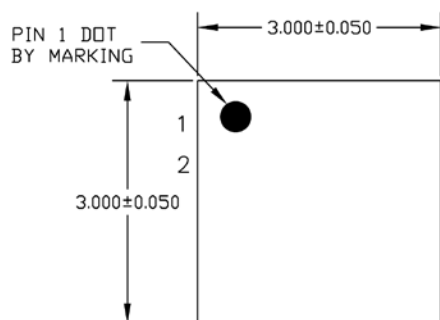
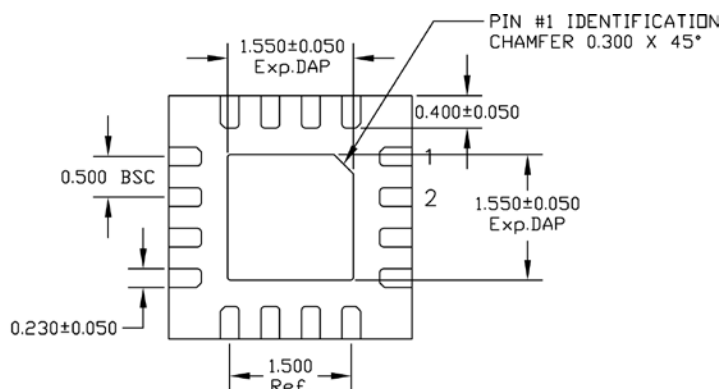


Figure 12. LVDS Interface (DC-Coupled)

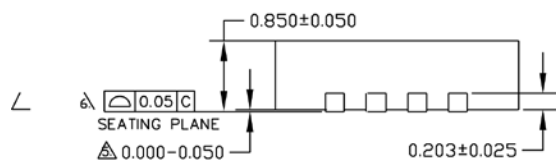
Package Information



TOP VIEW



BOTTOM VIEW



SIDE VIEW

NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
 2. MAX. PACKAGE WARPAGE IS 0.05 mm.
 3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
 4. PIN #1 ID ON TOP WILL BE LASER/INK MARKED.
- ⚠ APPLIED ONLY FOR TERMINALS.
- ⚠ APPLIED FOR EXPOSED PAD AND TERMINALS.

16-Pin (3mm x 3mm) QFN

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